SunLED
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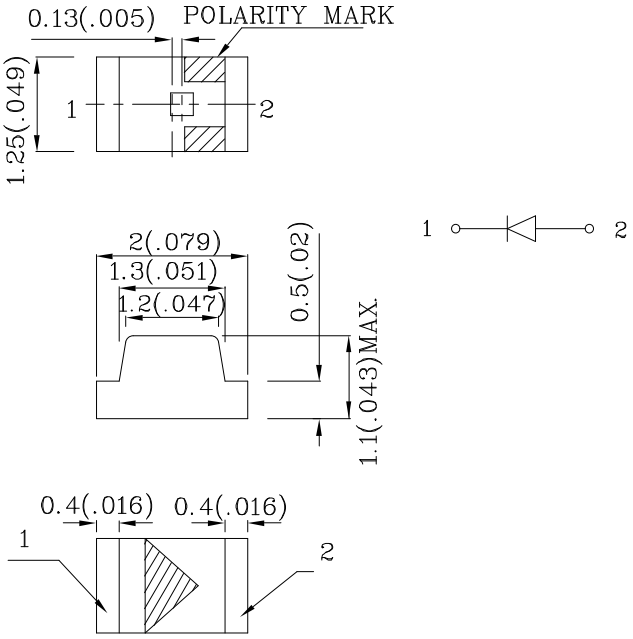
Part Number: **ZM2BG54W**

2.0x1.25mm SMD CHIP LED LAMP

PRELIMINARY SPEC

Features

- 2.0mmx1.25mm SMT LED,1.1mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.





ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

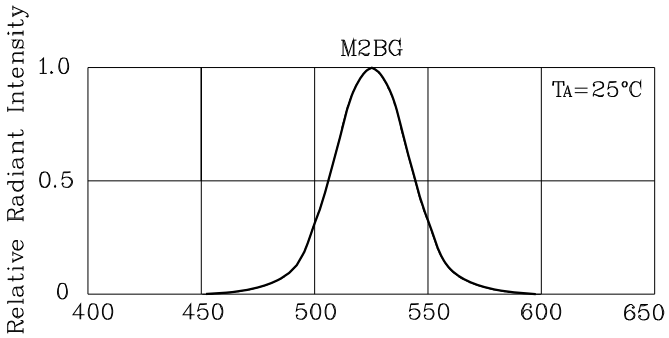
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1(0.004") unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A=25°C)		**M2BG (InGaN)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	100	mA
Power Dissipation	P_T	111	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		1000	V

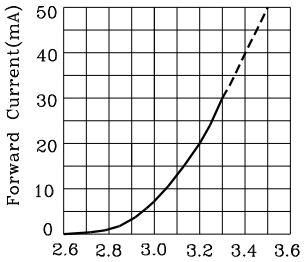
Operating Characteristics (T_A=25°C)		**M2BG (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.2	V
Forward Voltage (Max.) (I_F=20mA)	V_F	3.7	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength Of Peak Emission (Typ.) (I_F=20mA)	λ P	525	nm
Wavelength Of Dominant Emission (Typ.) (I_F=20mA)	λ D	535	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	Δλ	39	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	65	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
ZM2BG54W	Green	InGaN	Water Clear	380	795	525	120°

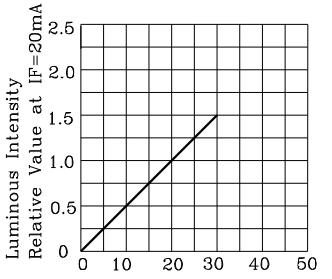


RELATIVE INTENSITY Vs. WAVELENGTH

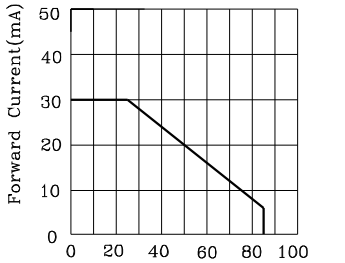
❖ **M2BG**



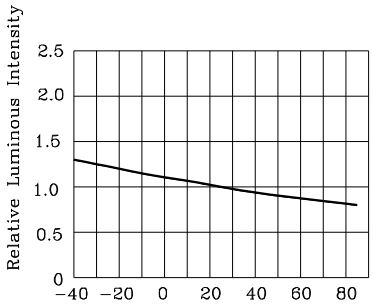
FORWARD CURRENT Vs.
FORWARD VOLTAGE



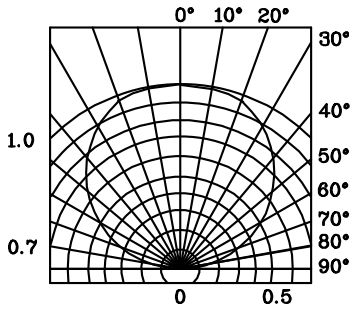
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

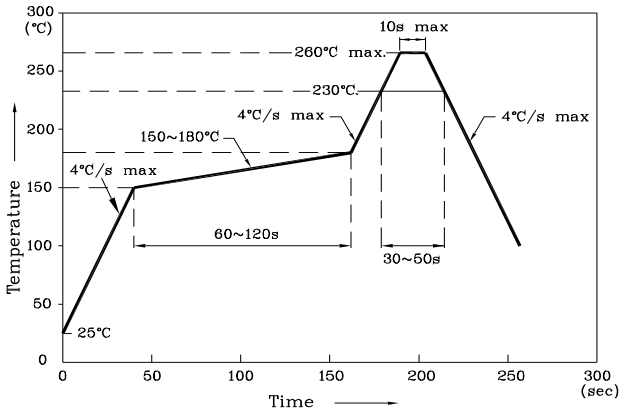


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



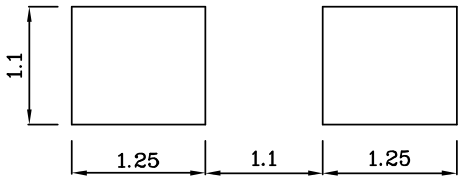
SPATIAL DISTRIBUTION

Reflow Soldering Profile For Lead-free SMT Process.

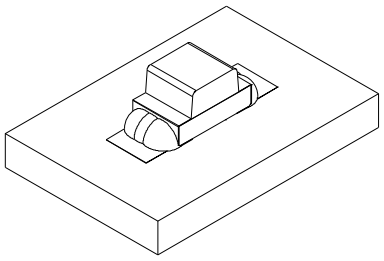


Notes:
1. Maximum soldering temperature should not exceed 260℃.
2. Recommended reflow temperature: 145℃-260℃.
3. Do not put stress to the epoxy resin during high temperatures conditions.

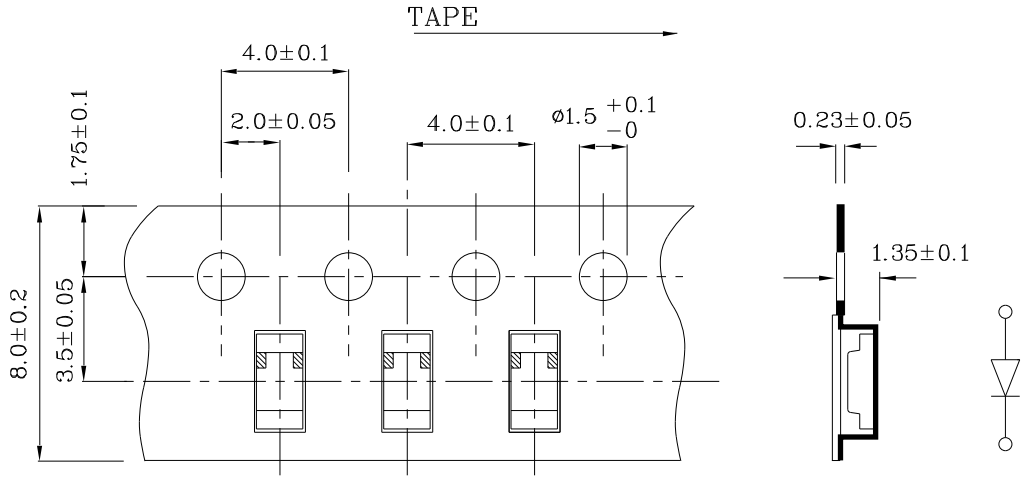
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:
1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V
Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS ZM2BG54W

